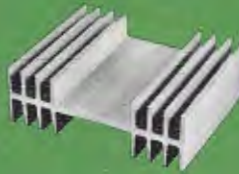
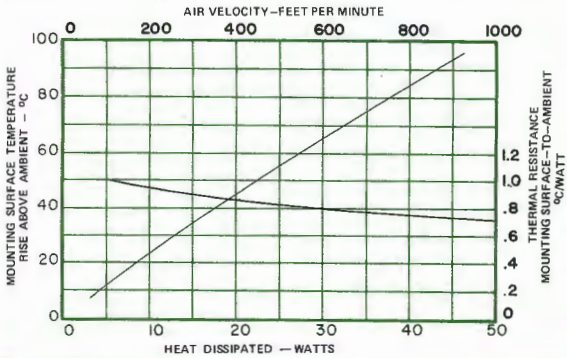


6135 SERIES

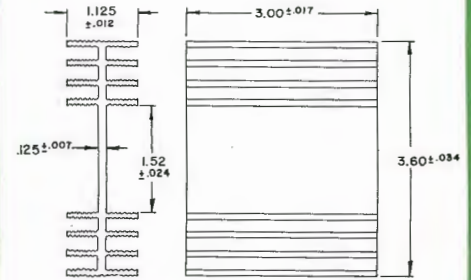
HIGH PERFORMANCE COOLER — FOR POWER SEMICONDUCTORS

The 6135 is an extruded heat sink with serrated fins on both sides. Accommodates all power devices. Recommended for forced convection and general purpose applications. See page 35 for available hole patterns.



6135

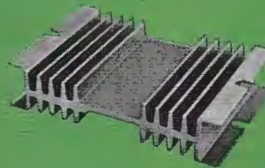
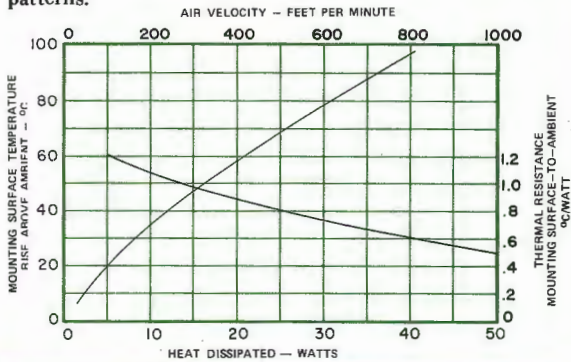
WEIGHT
.2934 lbs.



6427 SERIES

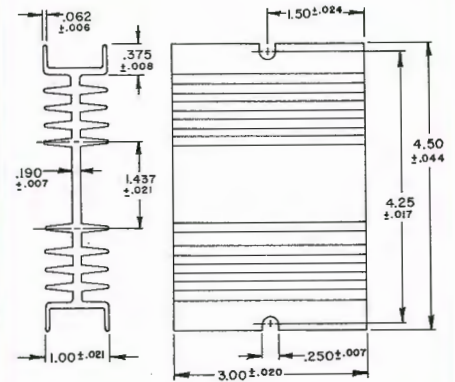
HIGH PERFORMANCE COOLER — FOR POWER SEMICONDUCTORS

The 6427 is an extruded heat sink with fins on both sides. Accommodates all power devices. Recommended where stacking of heat sinks is required. See page 35 for available hole patterns.



6427

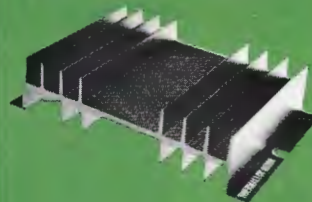
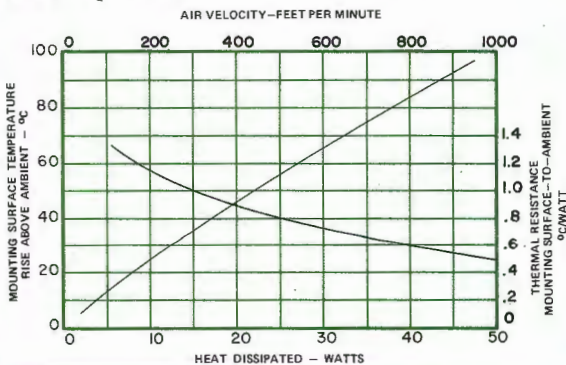
WEIGHT
.4363 lbs.



6500 SERIES

LOW COST EXTRUDED COOLER — FOR POWER SEMICONDUCTORS

The 6500 is an extruded heat sink with fins on both sides. Accommodates all power devices. Recommended where low cost and light weight are important. See page 35 for available hole patterns.



6500

WEIGHT
.2511 lbs.

